

1. Disassembly Procedures:

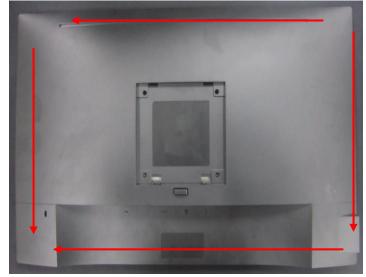
Step	Figure	Remark
S1.Before disassemble	Ret.	Turn off power, Unplug external cablesfrom product
S2. Remove the stand		Press the button on the red then pull out the stand upward, stand will be remove.



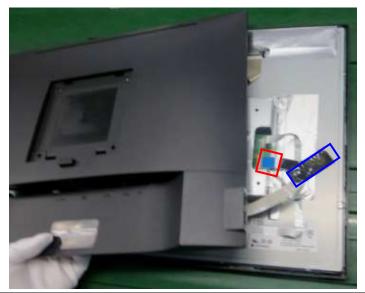
Use a Philips-head screwdriver to remove 4 screws for unlocking mechanisms.

(No.1~4 screw size=M4x10; Torque=12±2kgf.cm)

S3.Remove the REAR COVER.



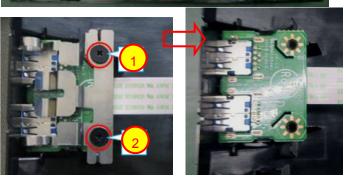
Use Penknife to separate the bezel and rear cove follow the arrows in sequence



Tear down black tape then release the USB cable in red, you can take out rear cover.



S4.Remove the USB board and key board



Disconnect the pins.

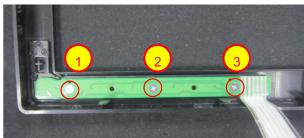
Use a Philips-head screwdriver to remove 2 screws for unlocking USB board.

size=Q3x4; Torque=4±1kgf.cm)

(No.1~2 screw

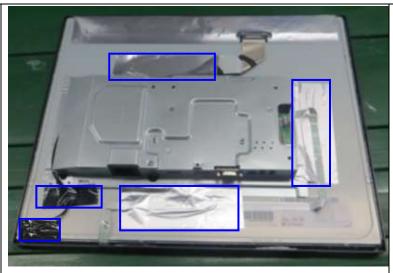
S5.Remove the key board





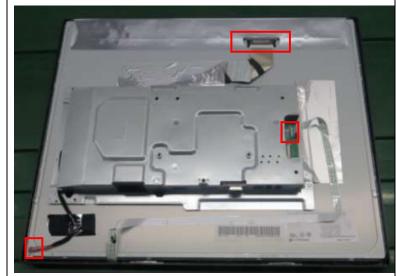
Use a Philips-head screwdriver to remove 3 screws for unlocking key board

(No.1~3 screw size=M2x2.5; Torque=0.9±0.4kgf.cm)

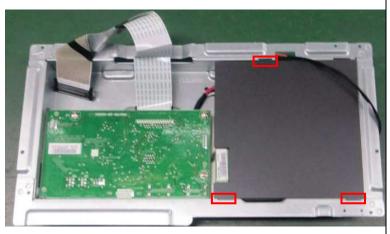


S6. Remove Main fram from Panel

- 1. Tear down tape in blue.
- 2.Disconnect cable in red

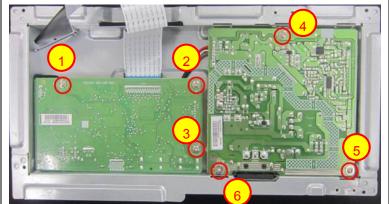


S7. Remove the Mylar of Power Board



Tear out connect in red, remove the Mylar



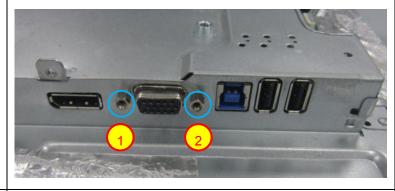


S8. Remove the **Main and Power Board**

Use a Philips-head screwdriver to remove 6 screws for unlocking Main board and Power board

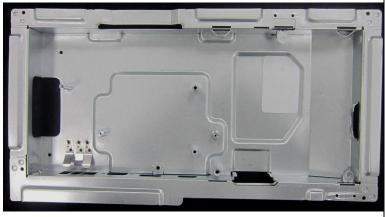
(No.1~5 screw size=D3x6; Torque=6±1kgf.cm

No.6 screw size=M4x6; Torque=6±1kgf.cm)



Use a hex screwdriver to remove 2 screws for unlocking mainboard (No.1~2 Hex screw Torque= 4.5 ± 0.5 kgf.cm)

S9.Mainframe



Mainframe





2. Product material information

The following substances, preparations, or components should be disposed of or recovered separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

Capacitors / condensers (containing	No used	
PCB/PCT)		
Mercury containing components	No used	
Batteries	No used	
Printed circuit boards (with a surface	Product has printed circuit boards (with a	
greater than 10 square cm)	surface greater than 10 square cm)	
Component contain toner, ink and liquids	No used	
Plastic containing BFR	No used	
Component and waste contain asbestos	No used	
CRT	No used	
Component contain CFC, HCFC, HFC	No used	
and HC		
Gas discharge lamps	No used	
LCD display > 100 cm2	Product has an LCD greater than 100 cm2	
External electric cable	Product has external cables	
Component contain refractory ceramic	No used	
fibers		
Component contain radio-active	No used	
substances		
Electrolyte capacitors (height	Product has electrolyte capacitors	
> 25mm, diameter > 25mm)	(height > 25mm, diameter > 25mm)	

3. Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description:

- Phillip head Screwdriver
- Hex Screwdriver
- Penknife
- Soldering iron and absorber